[CONNECTED PACKAGING FOR CHILDREN'S TOYS/SELINKO AND NXP SEMICONDUCTORS]

TITLE	Selinko and NXP join to provide connected packaging for children's toys	
COMPANY /		
ORGANIZATION		
	SELINKO	
WEWWORDD	EVERY OBJECT HAS AN IDENTITY	
KEYWORDS	NFC, anti-counterfeiting, brand protection	
INDUSTRY AREA(S)	Point of Purchase – Retail Commonly counterfeited products	
AFFECTED	Commonly counterreneu products	
ISSUE	Toys are currently the 6 th most frequently counterfeited product, with nearly one in ten	
ADDRESSED	toys in Europe being a counterfeit, accounting for an annual loss of approximately 1.5 billion euros. Brands must explore and innovate new ways to protect themselves from IP infringement and financial losses.	
SOLUTION	Technology company Selinko has team up with NXP, a semiconductor manufacturing company, to provide connected packaging to a new line of children's toys called Lini Cube in an effort combat counterfeiting. To do this, Lini Cube will be integrating NXP's secure NFC chip, the MIFARE Ultralight C, into its packaging, combined with Selinko's product identification platform and mobile app.	
	The MIFARE Ultralight C NFC chip wi connect the Lini Cube products/packaging to the Internet of Things (IoT), while Selinko software will allow for marketing services to be accessed by consumers and provid authentication and gray market detection. A of these features are activated by scanning the package with an NFC-enabled smartphore and Selinko's mobile app.	o Image: Constraint of the constraint
EXPECTED BENEFITS	Brand- and consumer-protection: Selinko and NXP's security measures provide anti-counterfeiting features for high-value products such as Lini Cubes while also providing additional marketing services for customers to take advantage of. Using familiar NFC technology, these features are easy and fast to use for distributors and purchasers, requiring only a smart phone and Selinko's mobile app.	
CASE LINK	AIPIA, Anti-counterfeiting is now Child's Play http://www.aipia.info/news-Anti-counterfeiting-is-now-Child-s-Play-621.php	
	Mifare, Educational toy 'Lini Cube' connects its packaging thanks to Selinko technology and NXP's MIFARE Ultralight C chip <u>https://www.mifare.net/educational-toy-lini-cube-connects-its-packaging-thanks-to-</u> selinko-technology-and-nxps-mifare-ultralight-c-chip/	
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